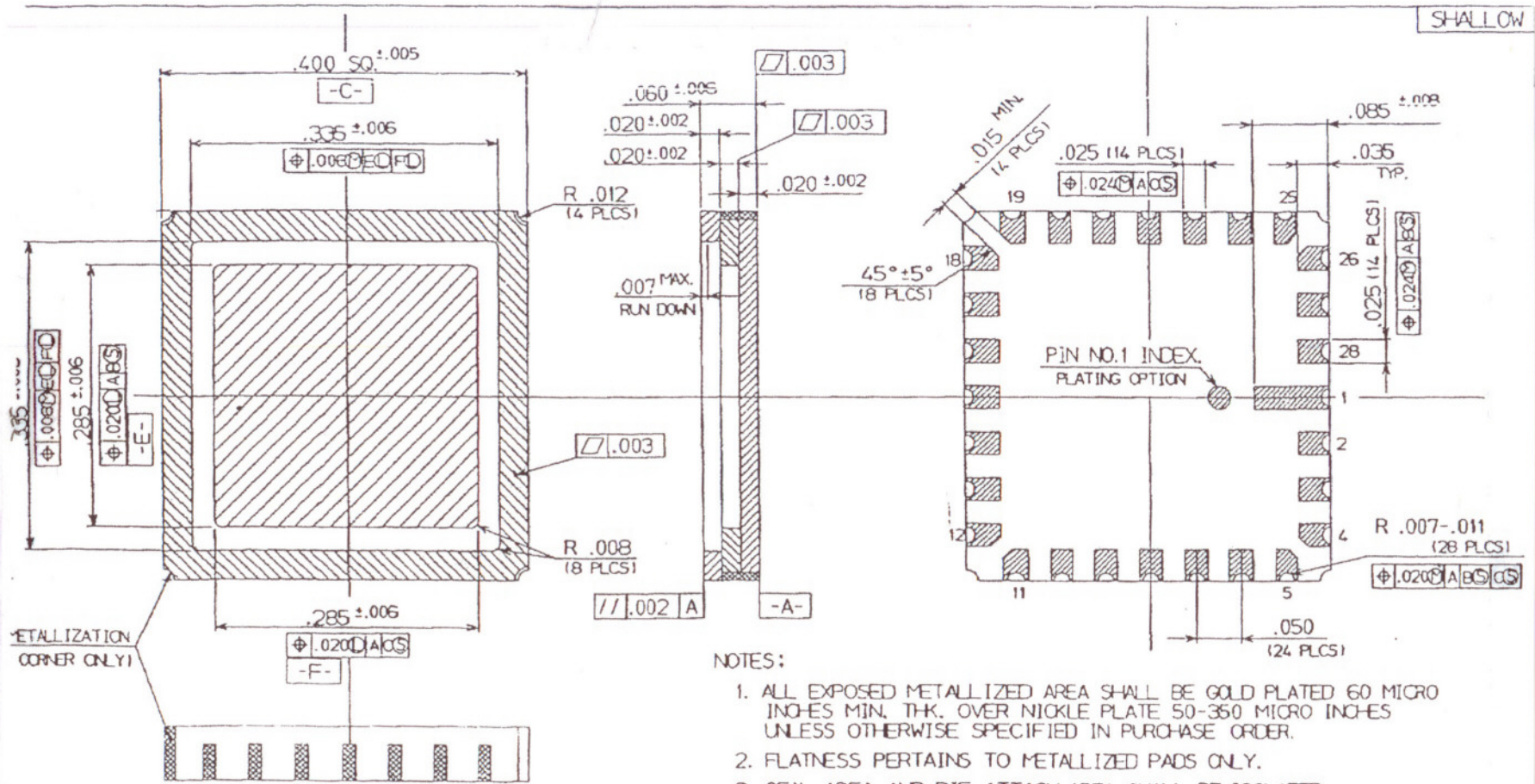


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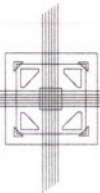


NOTES:

1. ALL EXPOSED METALLIZED AREA SHALL BE GOLD PLATED 60 MICRO INCHES MIN. THK. OVER NICKLE PLATE 50-350 MICRO INCHES UNLESS OTHERWISE SPECIFIED IN PURCHASE ORDER.
2. FLATNESS PERTAINS TO METALLIZED PADS ONLY.
3. SEAL AREA AND DIE ATTACH AREA SHALL BE ISOLATED FROM ALL LEADS. (ZERO GROUND)

S=C
D=C

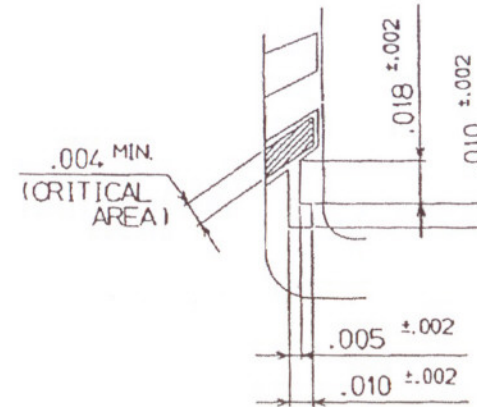
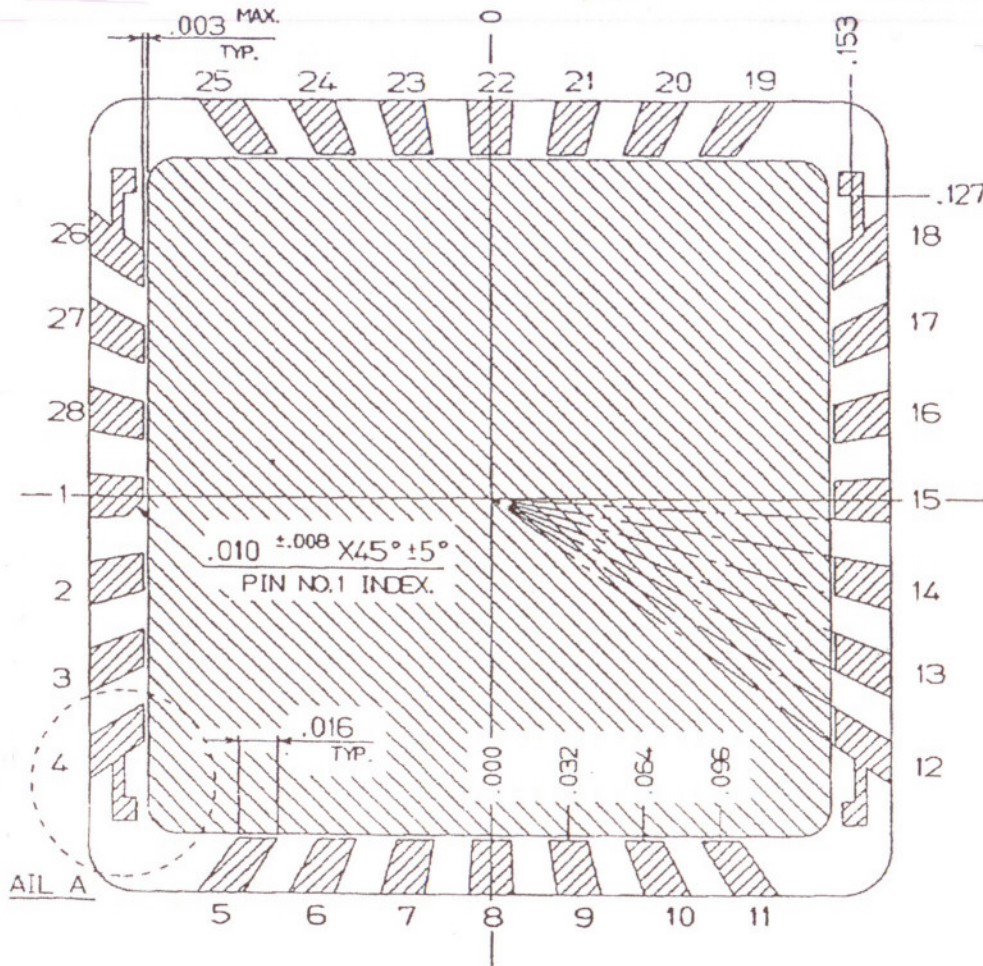
				180SD22436W001-H		CMD-28-03		
NAME 28 LCC (1.285 SQ. CAV.)				TOLERANCES: UNLESS OTHERWISE SPECIFIED	DRAWN N.H.	CHECKED A.Y.	APPROVED H.M.	DATE 29 JUL '94
SCALE 9/1				MATERIAL KYOCERA A-440	± .005			
KYOCERA				KYOCERA CORPORATION KYOTO JAPAN		DRAWING NO. PB-C92586		SHEET 1/2



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THIS CRITICAL AREA SHALL BE GUARANTEED THE MIN. VALUE TO ITS BASIC DIMENSION EVEN IF THERE WILL BE ANY DEVIATION FROM THE DIMENSION AND MISSING PLATING IN WIRE BOND PADS.

DETAIL A

ALL DIMENSION ARE BASIC UNLESS OTHERWISE TOLERANCED PART IS SYMMETRICAL ABOUT EXCEPT AS SHOWN.

WIRE BOND TRUE POSITION : $\oplus .004 \ominus$
 WIRE BOND GAP : .002 MIN.
 WIRE BOND CRITICAL AREA : .004 MIN.

				NAME 28 LCC (1.285 SQ. CAV.)		TOLERANCES: UNLESS OTHERWISE SPECIFIED		DRAWN N.H.		CHECKED A.Y.		APPROVED M.K.		DATE 29 JUL '94	
				SCALE 20/1		MATERIAL KYOCERA A-440									
				DATE		DRAWN		CHECKED		APPROVED		DRAWING NO. PB-C92586		SHEET 2/2	
				KYOCERA		KYOCERA CORPORATION KYOTO JAPAN									

